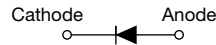


## Ultrafast Soft Recovery Diode, 150 A FRED Pt<sup>®</sup>


 PowerTab<sup>®</sup>


### FEATURES

- Ultrafast recovery time
- 175 °C max. operating junction temperature
- Screw mounting only
- AEC-Q101 qualified
- PowerTab<sup>®</sup> package
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)


**RoHS**  
 COMPLIANT  
 HALOGEN  
**FREE**

### LINKS TO ADDITIONAL RESOURCES



3D Models

PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	150 A
$V_R$	600 V
$V_F$ at $I_F$	1.08 V
$I_{FSM}$	1200 A
$t_{rr}$ (typ.)	50 ns
$T_J$ max.	175 °C
Snap factor	0.5
Package	PowerTab <sup>®</sup>
Circuit configuration	Single

### BENEFITS

- Reduced RFI and EMI
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

### DESCRIPTION/APPLICATIONS

These diodes are optimized to reduce losses and EMI/RFI in high frequency power conditioning systems. The softness of the recovery eliminates the need for a snubber in most applications. These devices are ideally suited for HF welding, power converters and other applications where switching losses are not significant portion of the total losses.

### MECHANICAL DATA

**Case:** PowerTab<sup>®</sup>

Molding compound meets UL 94 V-0 flammability rating

**Terminal:** nickel plated, screwable

ABSOLUTE MAXIMUM RATINGS				
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Cathode to anode voltage	$V_R$		600	V
Continuous forward current	$I_{F(AV)}$	$T_C = 89\text{ °C}$	150	A
Single pulse forward current	$I_{FSM}$	$T_C = 25\text{ °C}$	1200	
Operating junction and storage temperatures	$T_J, T_{Stg}$		-55 to +175	°C

ELECTRICAL SPECIFICATIONS ( $T_J = 25\text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Breakdown voltage, blocking voltage	$V_{BR}, V_R$	$I_R = 200\text{ }\mu\text{A}$	600	-	-	V
Forward voltage	$V_F$	$I_F = 150\text{ A}$	-	1.27	1.63	
		$I_F = 150\text{ A}, T_J = 125\text{ °C}$	-	1.15	1.43	
		$I_F = 150\text{ A}, T_J = 175\text{ °C}$	-	1.08	1.32	
Reverse leakage current	$I_R$	$V_R = V_R$ rated	-	-	8	$\mu\text{A}$
		$T_J = 150\text{ °C}, V_R = V_R$ rated	-	-	0.5	mA
Junction capacitance	$C_T$	$V_R = 600\text{ V}$	-	70	-	pF
Series inductance	$L_S$	Measured lead to lead 5 mm from package body	-	3.5	-	nH

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25\text{ }^\circ\text{C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Reverse recovery time	$t_{rr}$	$I_F = 1.0\text{ A}$ , $di_F/dt = 100\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	50	-	ns	
		$I_F = 1.0\text{ A}$ , $di_F/dt = 200\text{ A}/\mu\text{s}$ , $V_R = 30\text{ V}$	-	40	-		
		$T_J = 25\text{ }^\circ\text{C}$	-	100	-		
		$T_J = 125\text{ }^\circ\text{C}$	-	210	-		
Peak recovery current	$I_{RRM}$	$I_F = 50\text{ A}$ $V_R = 200\text{ V}$ $di_F/dt = 200\text{ A}/\mu\text{s}$	$T_J = 25\text{ }^\circ\text{C}$	-	10.5	-	A
			$T_J = 125\text{ }^\circ\text{C}$	-	22	-	
Reverse recovery charge	$Q_{rr}$		$T_J = 25\text{ }^\circ\text{C}$	-	550	-	nC
			$T_J = 125\text{ }^\circ\text{C}$	-	2350	-	

<b>THERMAL - MECHANICAL SPECIFICATIONS</b>						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal resistance, junction to case	$R_{thJC}$		-	-	0.35	K/W
Typical thermal resistance, case to heatsink	$R_{thCS}$	Mounting surface, flat, smooth and greased	-	0.2	-	
Weight			-	-	5.02	g
Mounting torque			1.2 (10)	-	2.4 (20)	N · m (lbf · in)
Marking device		Case style PowerTab®	EBU15006H			

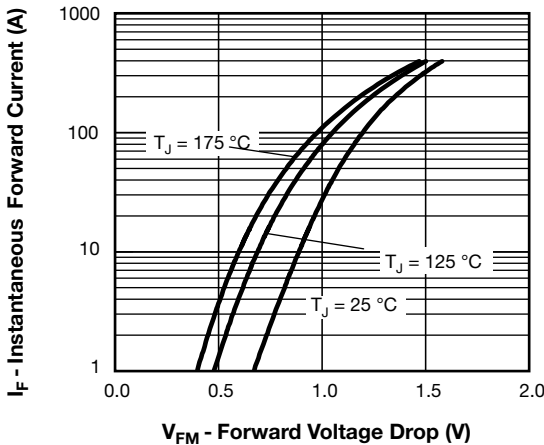


Fig. 1 - Maximum Forward Voltage Drop Characteristics

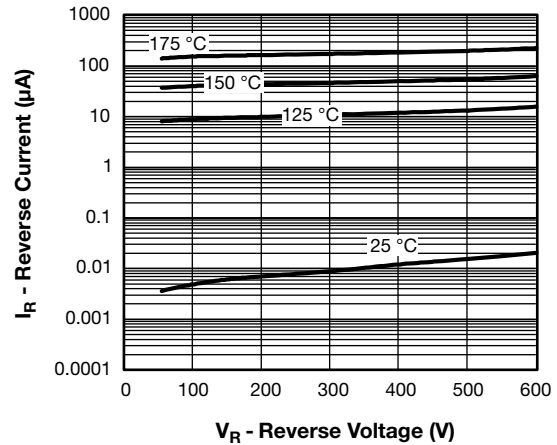


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

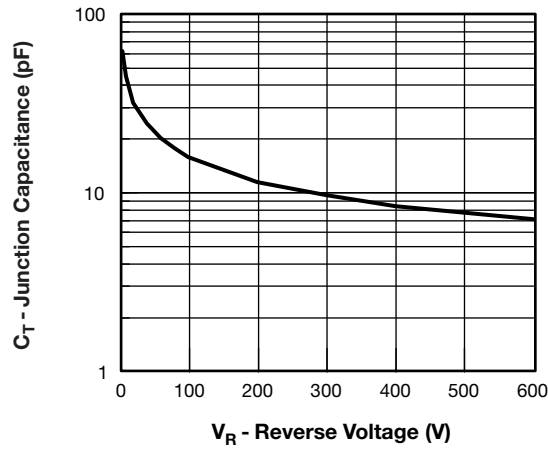


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

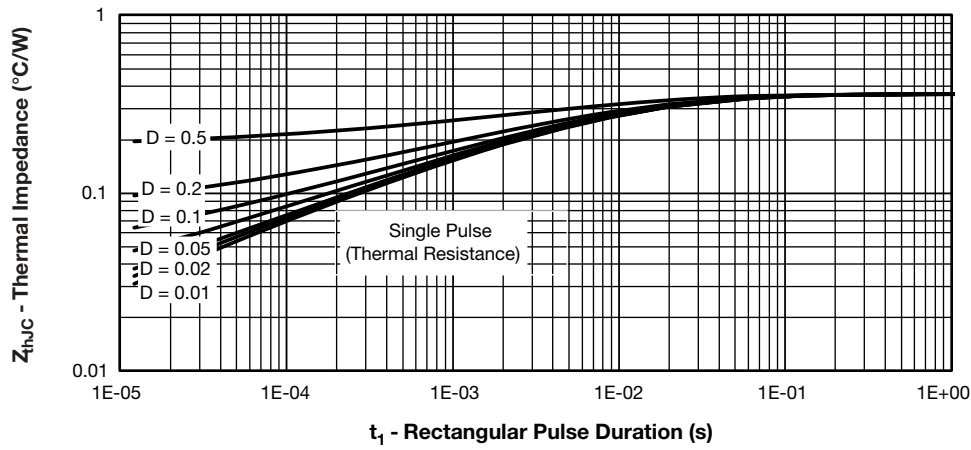


Fig. 4 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics

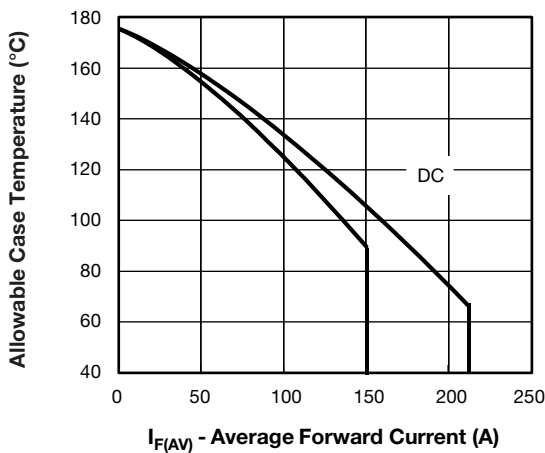


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

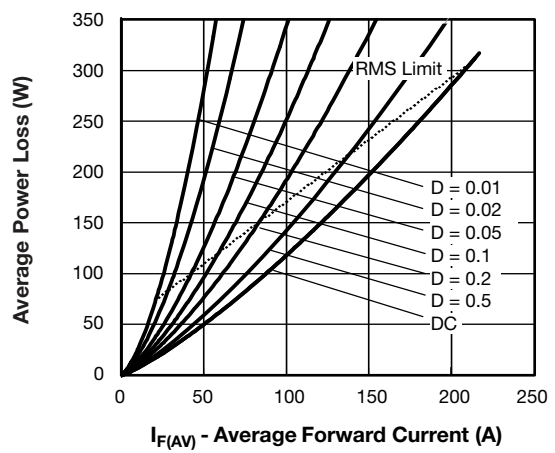


Fig. 6 - Forward Power Loss Characteristics

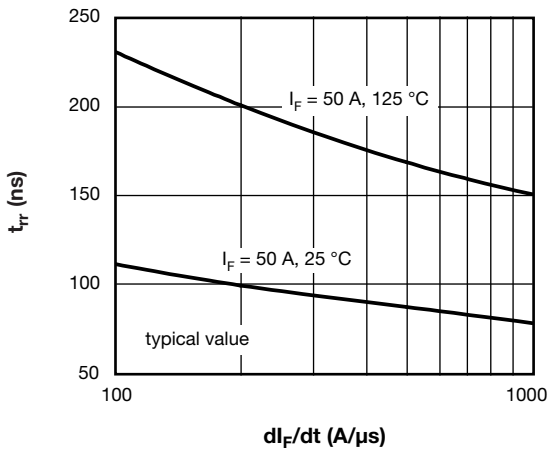


Fig. 7 - Typical Reverse Recovery Time vs.  $di_F/dt$

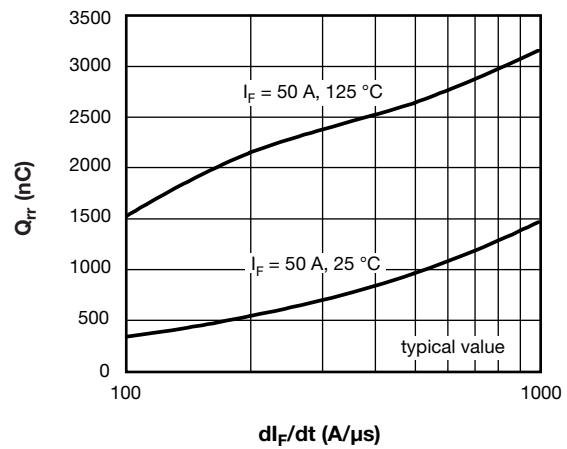
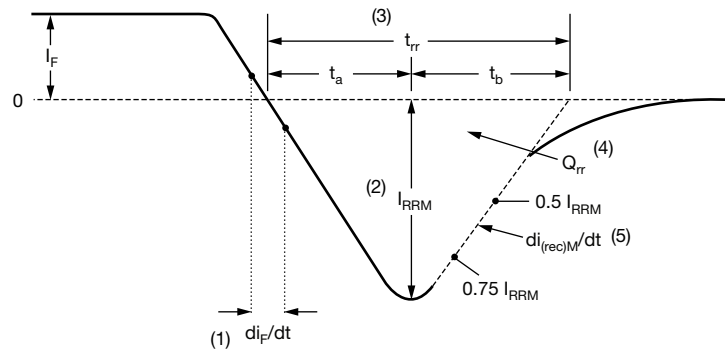


Fig. 8 - Typical Stored Charge vs.  $di_F/dt$



- (1)  $di_F/dt$  - rate of change of current through zero crossing
- (2)  $I_{RRM}$  - peak reverse recovery current
- (3)  $t_{rr}$  - reverse recovery time measured from zero crossing point of negative going  $I_F$  to point where a line passing through  $0.75 I_{RRM}$  and  $0.50 I_{RRM}$  extrapolated to zero current.

- (4)  $Q_{rr}$  - area under curve defined by  $t_{rr}$  and  $I_{RRM}$

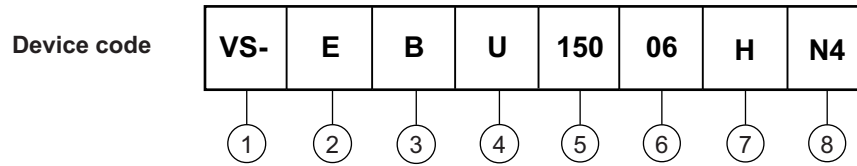
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

- (5)  $di_{(rec)M}/dt$  - peak rate of change of current during  $t_b$  portion of  $t_{rr}$

Fig. 9 - Reverse Recovery Waveform and Definitions



## ORDERING INFORMATION TABLE



- 1** - Vishay Semiconductors product
- 2** - Single diode
- 3** - PowerTab®
- 4** - Ultrafast recovery
- 5** - Current rating (150 = 150 A)
- 6** - Voltage rating (06 = 600 V)
- 7** - H = AEC-Q101 qualified
- 8** - Environmental digit:  
N4 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

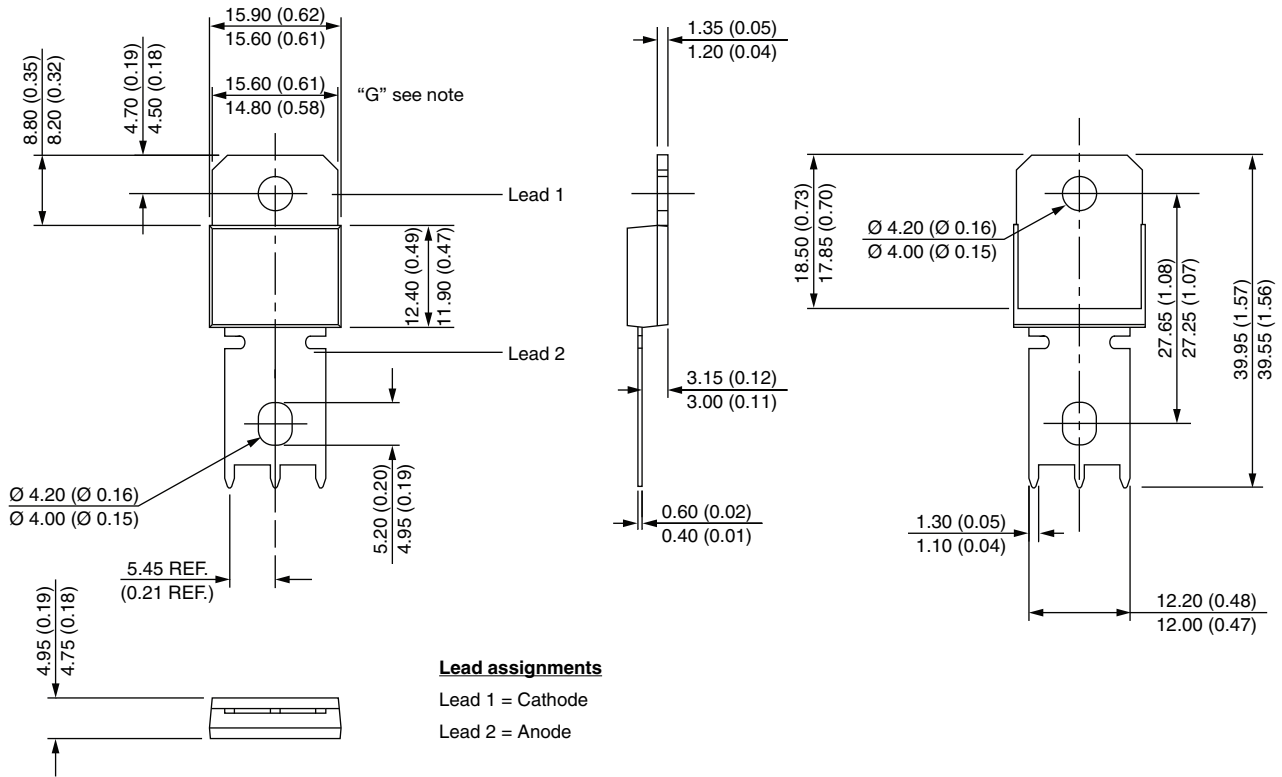
ORDERING INFORMATION (Example)		
PREFERRED P/N	BASE QUANTITY	PACKAGING DESCRIPTION
VS-EBU15006HN4	25/tube	Antistatic plastic tube

LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95240">www.vishay.com/doc?95240</a>
Part marking information	<a href="http://www.vishay.com/doc?95467">www.vishay.com/doc?95467</a>
Application note	<a href="http://www.vishay.com/doc?95179">www.vishay.com/doc?95179</a>
SPICE model	<a href="http://www.vishay.com/doc?97099">www.vishay.com/doc?97099</a>



### PowerTab®

**DIMENSIONS** in millimeters (inches)



**Note:**  
Outline conform to JEDEC® TO-275, except for dimension "G" only



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